506097112 06/09/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KENTARO TODA	06/05/2020

RECEIVING PARTY DATA

Name:	JAPAN AVIATION ELECTRONICS INDUSTRY, LIMITED	
Street Address:	t Address: 21-1, DOGENZAKA 1-CHOME	
City:	SHIBUYA-KU, TOKYO	
State/Country:	JAPAN	
Postal Code:	150-0043	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16896314

CORRESPONDENCE DATA

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	20147	
NAME OF SUBMITTER:	OF SUBMITTER: TAYLER MCDONALD	
SIGNATURE:	IATURE: /Tayler McDonald/	
DATE SIGNED:	06/09/2020	
	This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 1

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PATENT 506097112 REEL: 052874 FRAME: 0704

Combined Declaration and Assignment for Utility or Design Application

Title of Invention	CONNECTION STRUCTURE, FORMING METHOD OF CONNECTION STRUCTURE AND CABLE OF CONNECTION STRUCTURE			
As the below	w named inventor, I her	reby declare that:		
This declaration [x] The attached application, or is directed to: [J United States application or PCT international application number filed on				
The above-	dentified application wa	as made or authorized to be made by	y me.	
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.				
In consideration of value received, I sell and assign to <u>Japan Aviation Electronics Industry, Limited</u> , having a business address at <u>21-1</u> , <u>Dogenzaka 1-chome</u> , <u>Shibuya-ku</u> , <u>Tokyo 150-0043</u> , <u>Japan</u> , its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention, and in and to all applications for patent and patents for said invention, in all countries of the world, including all divisions, reissues, continuations, substitutions and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of intellectual property, including rights of priority, resulting from the filing of any of said applications.				
I authorize said Assignee to file and prosecute an application or applications for patent for said invention as the applicant, and I request any official whose duty it is to issue patents, to issue any patent on said invention to said Assignee.				
I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention in all countries.				
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.				
LEGAL NAME OF INVENTOR				
Ke	ntaro TODA	Kentapo Toda	June 5, 2020	
Invento	or (printed name)	Signature	Date	

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> PATENT REEL: 052874 FRAME: 0705

RECORDED: 06/09/2020